

# RF SWITCH CG2214M6

# L, S-band Medium Power SPDT Switch

# **DESCRIPTION**

The CG2214M6 is a pHEMT GaAs SPDT (<u>Single Pole Double Throw</u>) switch. This device can operate from 0.05 to 3.0 GHz, having low insertion loss and high isolation.

# **FEATURES**

- · Control voltage:
  - VC(H) = 1.8 to 5.0 V (3.0 V TYP.)VC(L) = -0.2 to 0.2 V (0 V TYP.)
- · Low insertion loss:

 $L_{ins}1 = 0.30 \text{ dB TYP.}$  @ f = 0.05 to 0.5 GHz

 $L_{ins}2 = 0.30 \text{ dB TYP.}$  @ f = 0.5 to 1.0 GHz

 $L_{ins}3 = 0.30 \text{ dB TYP.} @ f = 1.0 \text{ to } 2.0 \text{ GHz}$ 

 $L_{ins}4 = 0.35 \text{ dB TYP.}$  @ f = 2.0 to 2.5 GHz

L<sub>ins</sub>5 = 0.35 dB TYP. @ f = 2.5 to 3.0 GHz

High isolation :

ISL1 = 38 dB TYP. @ f = 0.05 to 0.5 GHz

ISL2 = 32 dB TYP. @ f = 0.5 to 1.0 GHz

ISL3 = 27 dB TYP. @ f = 1.0 to 2.0 GHz

ISL4 = 25 dB TYP. @ f = 2.0 to 2.5 GHz

ISL5 = 23 dB TYP. @ f = 2.5 to 3.0 GHz

Power handling :

 $P_{in}(0.5dB) = +32 dBm TYP. @ f = 3.0 GHz$ 

VC(H) = 3.0 V, VC(L) = 0 V

# **PACKAGE**

 6-pin lead-less mini mold package (1.5mm x 1.1mm x 0.55mm)



# **APPLICATIONS**

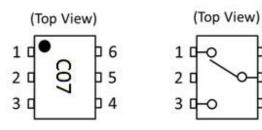
Wireless LAN (IEEE 802.11 b/g/n/ac)

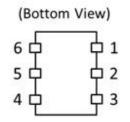
## ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Description
CG2214M6	CG2214M6-C2	6-pin lead-less mini mold package (Pb-Free)	C07	<ul> <li>Embossed tape 8 mm wide</li> <li>Pin 1, 6 face the perforation side of the tape</li> <li>MOQ 9 kpcs/reel</li> </ul>
CG2214M6-EVAL	CG2214M6-EVAL			Evaluation Board with DC block capacitors, power supply bypass capacitors, and RF and DC connectors     MOQ 1



# PIN CONFIGURATION AND INTERNAL BLOCK DIAGRAM





Pin No.	Pin Name
1	RF1
2	GND
3	RF2
4	VC2
5	RFC
6	VC1

# **TRUTH TABLE**

VC1	VC2	RFC-RF1	RFC-RF2
Low	High	ON	OFF
High	Low	OFF	ON

# **ABSOLUTE MAXIMUM RATINGS**

 $(TA = +25^{\circ}C. \text{ unless otherwise specified})$ 

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Parameter	Symbol	Rating	Unit
Control Voltage	VC	6.0 <sup>Note 1</sup>	V
Input Power	P <sub>in</sub> 1	+33 <sup>Note 2</sup>	dBm
	P <sub>in</sub> 2	+29 <sup>Note 3</sup>	dBm
Operating Ambient Temperature	T <sub>A</sub>	-45 ~ +85	°C
Storage Temperature	$T_{stg}$	-55 ~ +150	°C

b 6

b 5

Note 1.

- 1. |VC1 VC2| ≤ 6.0 V
  - 2.  $3.0V \le |VC1 VC2| \le 5.0 \text{ V}, f \ge 0.4 \text{ GHz}$
- 3.  $3.0V \le |VC1 VC2| \le 5.0 \text{ V}, 0.4\text{GHz} \ge f \ge 0.05\text{GHz}$

# RECOMMENDED OPERATING RANGE

(TA = +25°C, unless otherwise specified)

(17. = 120 c) difference of the med opening)							
Parameter	Symbol	MIN.	TYP.	MAX.	Unit		
Operating Frequency	f	0.05	-	3.0	GHz		
Switch Control Voltage (H)	VC(H)	+1.8	+3.0	+5.3	V		
Switch Control Voltage (L)	VC(L)	-0.2	0	+0.2	V		



# **ELECTRICAL CHARACTERISTICS 1**

(TA = +25°C, VC(H) = 3.0 V, VC(L) = 0 V, Zo = 50 Ω, DC Block Capacitance = 56 pF, unless otherwise specified)

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Insertion Loss	L <sub>INS</sub> 1	f=0.05 to 0.5GHz Note 1	-	0.30	0.50	dB
	L <sub>INS</sub> 2	f=0.5 to 1.0GHz	-	0.30	0.50	dB
	L <sub>INS</sub> 3	f=1.0 to 2.0GHz	-	0.30	0.50	dB
	L <sub>INS</sub> 4	f=2.0 to 2.5GHz	-	0.35	0.55	dB
	L <sub>INS</sub> 5	f=2.5 to 3.0GHz	-	0.35	0.55	dB
Isolation	ISL1	f=0.05 to 0.5GHz Note 1	35	38	-	dB
	ISL2	f=0.5 to 1.0GHz	29	32	-	dB
	ISL3	f=1.0 to 2.0GHz	24	27	-	dB
	ISL4	f=2.0 to 2.5GHz	22	25	-	dB
	ISL5	f=2.5 to 3.0GHz	20	23	-	dB
Return Loss	RL	f=0.05 to 3.0GHz Note 1	15	20	-	dB
0.1dB Loss Compression Input	P <sub>in(0.1dB)</sub>	f=0.05 ~ 0.5GHz Note 1	-	+26	-	dBm
Power Note 2		f=0.5 ~ 3.0GHz	-	+30	-	dBm
0.5dB Loss Compression Input	P <sub>in(0.5dB)</sub>	f=0.05 ~ 0.5GHz Note 1	-	+28	-	dBm
Power Note 3		f=0.5 ~ 3.0GHz	-	+32	-	dBm
2nd Harmonics	2f0	f=3.0GHz, P <sub>in</sub> =+20dBm	-	-85	-	dBc
3rd Harmonics	3f0	f=3.0GHz, P <sub>in</sub> =+20dBm	-	-85	-	dBc
3rd Order Input Intercept Point	IIP <sub>3</sub>	f=2.5GHz, 2-tone 1MHz Spacing	-	+58	-	dBm
Error Vector Magnitude	EVM	802.11g, 64QAM, 54Mbps Pin≦+25dBm	-	2.5	-	%
Switch Control Current	I <sub>CONT</sub>	RF none	-	1	10	uA
Switching Speed	tsw	50% CTL to 90/10% RF	-	50	-	ns

Note 1. DC block capacitance = 1000 pF at f = 0.05 to 0.5 GHz

<sup>2.</sup>  $P_{in(0.1dB)}$  is the measured input power level when the insertion loss increases 0.1dB more than that of the linear range.

<sup>3.</sup> P<sub>in(0.5dB)</sub> is the measured input power level when the insertion loss increases 0.5dB more than that of the linear range



# **ELECTRICAL CHARACTERISTICS 2**

(TA=+25°C, VC(H)=1.8V, VC(L)=0V, Zo=50Ω, DC Block Capacitance=56pF, unless otherwise specified)

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Insertion Loss	L <sub>INS</sub> 1	f=0.05 to 0.5GHz Note 1		0.30	0.50	dB
	L <sub>INS</sub> 2	f=0.5 to 1.0GHz		0.30	0.50	dB
	L <sub>INS</sub> 3	f=1.0 to 2.0GHz		0.30	0.50	dB
	L <sub>INS</sub> 4	f=2.0 to 2.5GHz		0.35	0.55	dB
	L <sub>INS</sub> 5	f=2.5 to 3.0GHz		0.35	0.55	dB
Isolation	ISL1	f=0.05 to 0.5GHz Note 1	35	38		dB
	ISL2	f=0.5 to 1.0GHz	29	32		dB
	ISL3	f=1.0 to 2.0GHz	24	27		dB
	ISL4	f=2.0 to 2.5GHz	22	25		dB
	ISL5	f=2.5 to 3.0GHz	20	23		dB
Return Loss	RL	f=0.05 to 3.0GHz Note 1	15	20		dB
0.1dB Loss Compression Input Power Note 2	P <sub>in(0.1dB)</sub>	f=0.05~0.5GHz Note 1		+19		dBm
input i owoi		f=0.5~3.0GHz		+23		dBm
0.5dB Loss Compression Input Power Note 3	P <sub>in(0.5dB)</sub>	f=0.05~0.5GHz Note 1		+22		dBm
		f=0.5~3.0GHz		+26		dBm
Switch Control Current	I <sub>CONT</sub>	RF none		1	10	uA
Switching Speed	T <sub>SW</sub>	50% CTL to 90/10% RF		50		ns

Note 1. DC block capacitance = 1000pF at f=0.05 to 0.5GHz

<sup>2.</sup>  $P_{in(0.1dB)}$  is the measured input power level when the insertion loss increases 0.1dB more than that of the linear range.

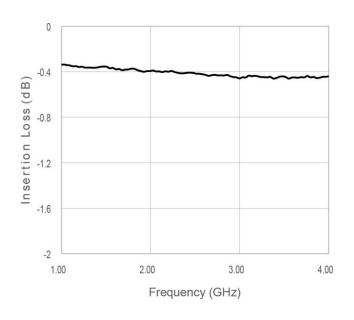
<sup>3.</sup> P<sub>in(0.5dB)</sub> is the measured input power level when the insertion loss increases 0.5dB more than that of the linear range.



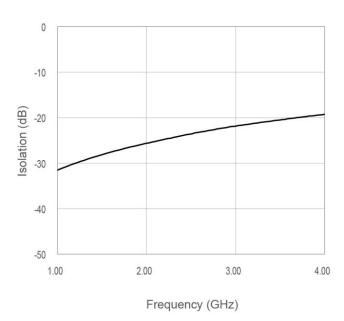
# **TYPICAL CHARACTERISTICS**

(Vc(H)=3V, Vc(L)=0V, T<sub>A</sub>=+25°C, DC Block Capacitance=56pF, through board loss is subtracted in insertion loss data)

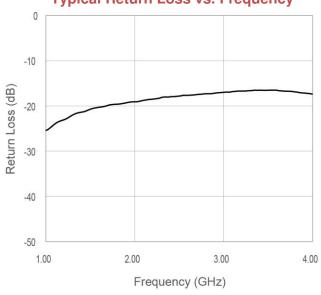
# **Typical Insertion Loss vs. Frequency**



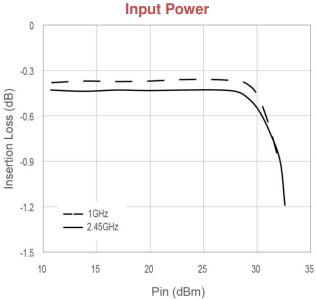
# Typical Isolation vs. Frequency





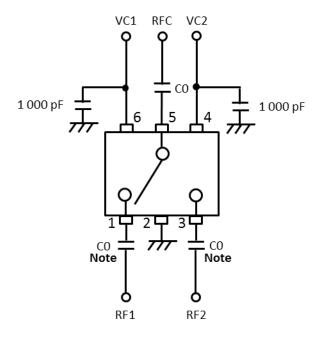


# Typical Insertion Loss vs.





# **EVALUATION CIRCUIT**

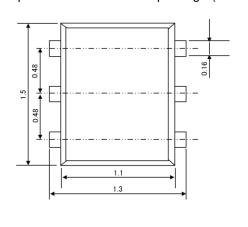


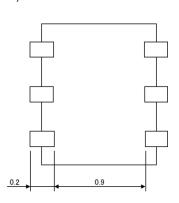
**Note** C0: 0.05 to 0.5 GHz 1000pF: 0.5 to 3.0 GHz 56pF

The application circuits and their parameters are for reference only and are not intended for use in actual designs. DC Blocking Capacitors are required at all RF ports.

# **PACKAGE DIMENSIONS**

6-pin lead-less mini mold package (Unit: mm)









# **RECOMMENDED SOLDERING CONDITIONS**

Recommended Soldering Conditions are available on CEL's Part Summary page under Associated Documents



# **REVISION HISTORY**

Version	Change to current version	Page(s)
CDS-0021-01 (Issue A) February 17, 2016	Initial datasheet	N/A
CDS-0021-02 (Issue B)	Added Eval Board ordering information	1, 2
March 29, 2016	Updated marking information	
CDS-0021-03 (Issue C) April 20, 2016	Updated Features section	1
CDS-0021-03 (Issue D) August 11, 2016	Removed "preliminary"	All
CDS-0025-01 (Issue A) September 14, 2016	Revise CDS No. CDS-0021-03 to CDS-0025-01	N/A
CDS-0025-01 (Issue B) January 11, 2017	Revised Electrical Characteristics table Added "Recommended Soldering Conditions" section	3, 5
CDS-0025-04 (Issue C) September 11, 2017	Updated Applications section Added Error Vector Magnitude parameter to Electrical Characteristics table 1, Added a second Electrical Characteristics table Added Typical Characteristics graphs section	1, 2, 3, 4, 5



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- Do not chemically make gas or powder with this product.
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